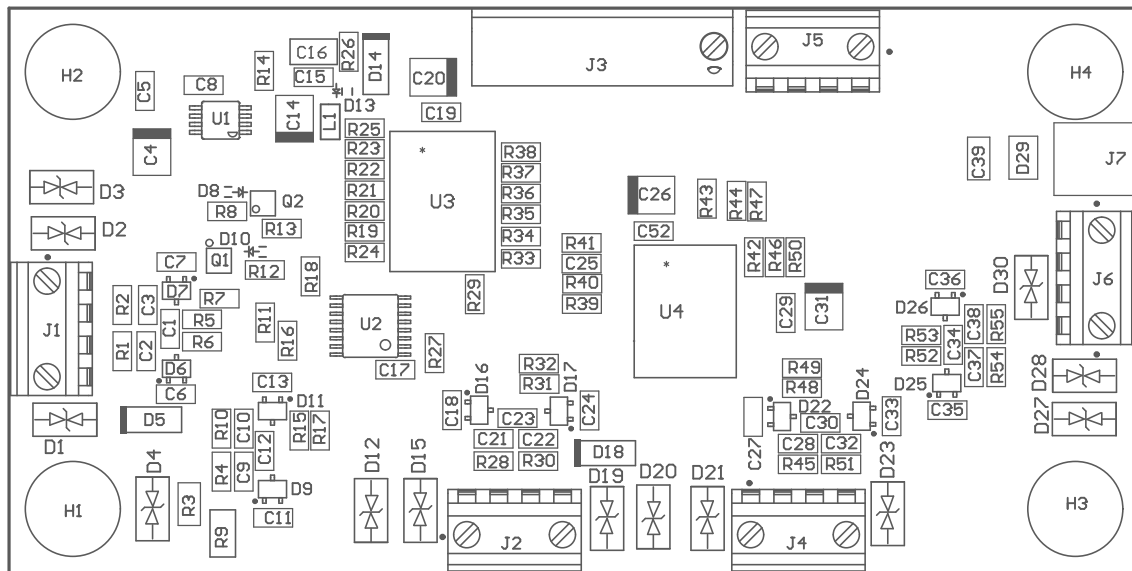


Z24 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

Z23 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.

Z22 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

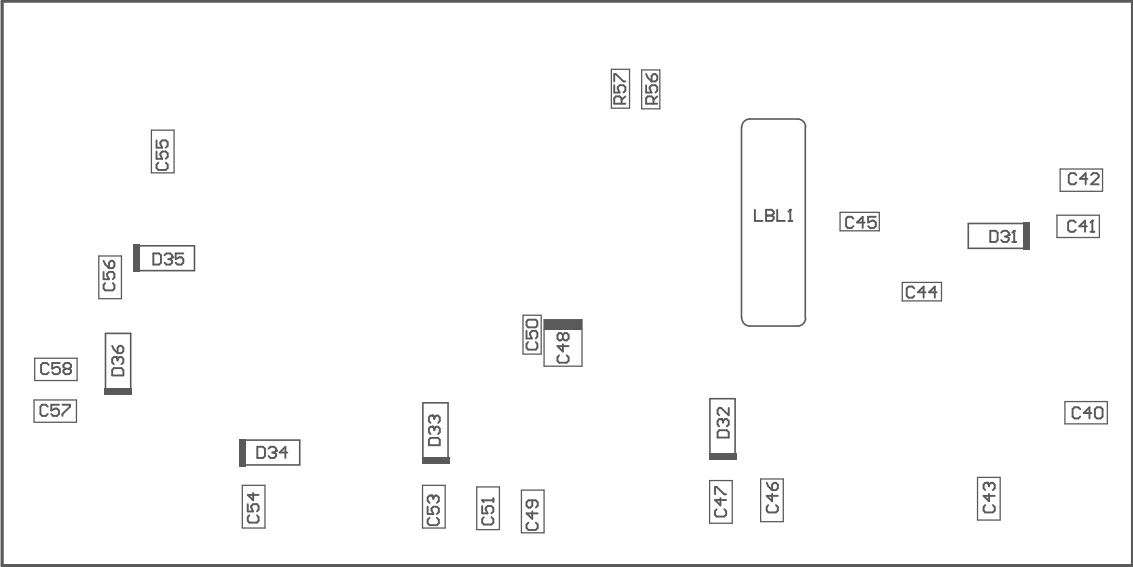
Z21 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.

ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00110	REV: E1	SUN REV: Not In VersionControl
LAYER NAME= ASSEMBLY TOP			
PLOT NAME = Top Assembly Drawing	GENERATED : 10/8/2014 6:48:38 PM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00110	REV: E1	SUN REV: Not In VersionControl
	LAYER NAME= ASSEMBLY BOTTOM		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/8/2014	6:48:38 PM	TEXAS INSTRUMENTS

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